

Application No.: 10/808854  
Docket No.: DC7000USCNT

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**REMARKS****I. Substance of the Interview**

Applicant appreciates the kind consideration shown by the Examiner in a recent interview held at the US Patent and Trademark Office with the undersigned and Ms Kate Redmond, on June 27, 2007. The present amendment is submitted in the above-captioned matter in response to matters discussed in the interview.

Applicant discussed with the Examiner CA 788009 (CA '009) and the '486 patent to Booij. CA '009 was recently submitted by Applicant along with other references in an Information Disclosure Statement; and in the interests of advancing prosecution Applicant considered it helpful to discuss the document given its strong apparent relevance to the instant case.

Applicant presented a sample main claim for consideration by the Examiner, and reviewed its rationale regarding why such a main claim is distinctive. (This main claim is shown as presently amended Claim 2). Applicant believes that by incorporating the limitation of the additive to precipitate the partially depolymerized polyamide, such a proposed claim is differentiated from both CA '009 and Booij.

**II. Claims Amendments Submitted in View of Discussions in the Recent Personal Interview**

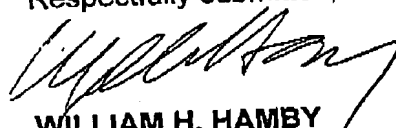
Applicant indicated that as a next step a full set of claims consistent with this change and taking into account the teachings of CA '009 and Booij might be submitted for formal consideration by the Examiner; and so have filed this Supplemental Response. Applicant also indicated that support for the change to Claim 2 can be found generally at page 6, line 26 of the specification.

With this submission Applicant respectfully submits that the instant claims are in a condition suitable for allowance.

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Respectfully submitted,



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Dated: July 11 2007

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